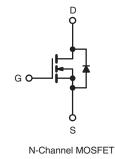




### Power MOSFET

PRODUCT SUMMA	RY .		
V <sub>DS</sub> (V)	400		
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 10 V$	0.55	
Q <sub>g</sub> (Max.) (nC)	6	2	
Q <sub>gs</sub> (nC)	1	0	
Q <sub>gd</sub> (nC)	3	0	
Configuration	Sin	igle	





#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

preferred The TO-247AC for package is commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because its isolated mounting hole. It also provides greater creepage distances between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFP340PbF
Lead (FD)-free	SiHFP340-E3
SnPb	IRFP340
	SiHFP340

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	400	Ň
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_C = 25 \degree C$ $T_C = 100 \degree C$		11	
Continuous Drain Current	VGS at TO V	T <sub>C</sub> = 100 °C	ID	6.9	A
Pulsed Drain Current <sup>a</sup>	•		I <sub>DM</sub>	44	
Linear Derating Factor				1.2	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	480	mJ
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	11	A
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	15	mJ
Maximum Power Dissipation	T <sub>C</sub> =	25 °C	PD	150	W
Peak Diode Recovery dV/dt <sup>c</sup>	•		dV/dt	4.0	V/ns
Operating Junction and Storage Temperature Rang	е		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	- °C
Soldering Recommendations (Peak Temperature)	for	10 s		300 <sup>d</sup>	
Mounting Torque	6.00 or 1	//3 screw		10	lbf ∙ in
Mounting Torque	0-32 OF 1	No Screw		1.1	N · m

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 50 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 6.9 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 11 \text{ A}$  (see fig. 12).

c.  $I_{SD} \le 11$  A, dl/dt  $\le 120$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 40 0.24 -						
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>				°C/W			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.83		1			
			•					
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ ,	unless otherv	vise noted)						
PARAMETER	SYMBOL		CONDITIC	ONS	MIN.	TYP.	MAX.	UNIT
Static		1			1	<b>I</b>	I	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	) V, I <sub>D</sub> = 25	i0 μA	400	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>I</sub>	<sub>D</sub> = 1 mA	-	0.49	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V	′ <sub>GS</sub> , I <sub>D</sub> = 25	50 µA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>G</sub>	<sub>is</sub> = ± 20 V	,	-	-	± 100	nA
		V <sub>DS</sub> = 4	00 V, V <sub>GS</sub>	= 0 V	-	-	25	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 320 V, \	/ <sub>GS</sub> = 0 V,	T <sub>J</sub> = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub>	= 6.6 A <sup>b</sup>	-	-	0.55	Ω
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> = 5	0 V, I <sub>D</sub> = 6	.6 A <sup>b</sup>	7.7	-	-	S
Dynamic		1			1	<b>I</b>	I	
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	1400	-	pF	
Output Capacitance	C <sub>oss</sub>			-	400	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	130	-		
Total Gate Charge	Qg				-	-	62	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		A, V <sub>DS</sub> = 320 V, g. 6 and 13 <sup>b</sup>	-	-	10	nC
Gate-Drain Charge	Q <sub>gd</sub>		300 H	g. o and to	-	-	30	
Turn-On Delay Time	t <sub>d(on)</sub>				-	14	-	
Rise Time	t <sub>r</sub>	- V== - 2	00 V, I <sub>D</sub> = <sup>-</sup>	10 Δ	-	27	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_{g} = 9.1 \Omega, R$			-	50	-	
Fall Time	t <sub>f</sub>				-	24	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") fro			-	5.0	-	
Internal Source Inductance	L <sub>S</sub>	package and ce die contact	nter of		-	13	-	nH
Drain-Source Body Diode Characteristic	s					•	•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	11	А	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction di	ode		-	-	44	~
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I	<sub>S</sub> = 11 A, \	$V_{\rm GS} = 0 \ \rm V^b$	-	-	2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	– T <sub>J</sub> = 25 °C, I <sub>F</sub> =	10 A di/d	t – 100 Δ/us <sup>b</sup>	-	330	660	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	ij = 20 0, if =	10 A, ui/u	ι – 100 Αγμογ	-	2.5	5.9	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn	-on time is	negligible (turn	I-on is doi	minated b	$y L_{S} and$	L <sub>D</sub> )

#### Notes

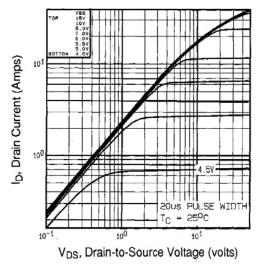
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$ 

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



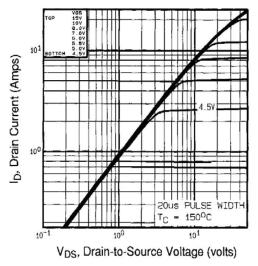


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

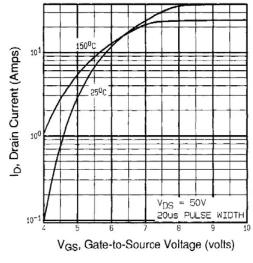


Fig. 3 - Typical Transfer Characteristics

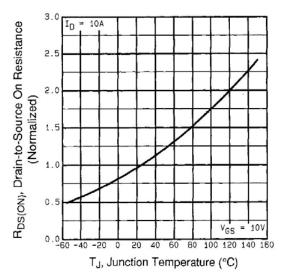


Fig. 4 - Normalized On-Resistance vs. Temperature

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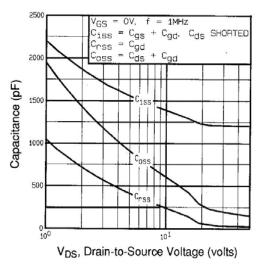


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

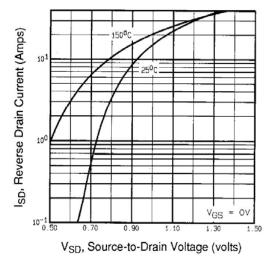


Fig. 7 - Typical Source-Drain Diode Forward Voltage

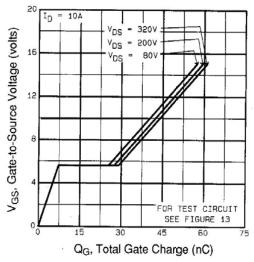
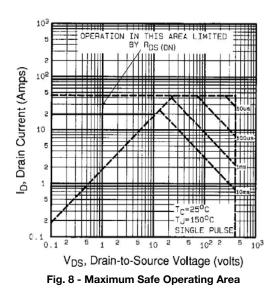


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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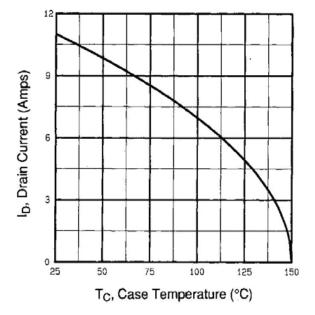


Fig. 9 - Maximum Drain Current vs. Case Temperature

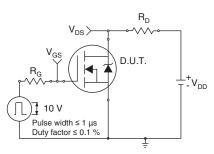


Fig. 10a - Switching Time Test Circuit

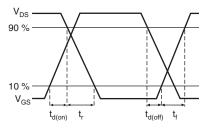


Fig. 10b - Switching Time Waveforms

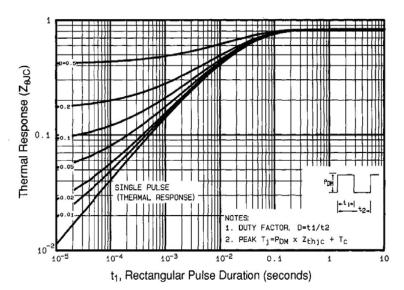


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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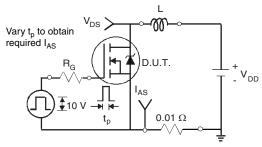


Fig. 12a - Unclamped Inductive Test Circuit

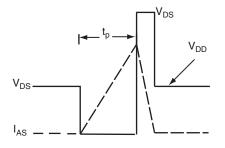
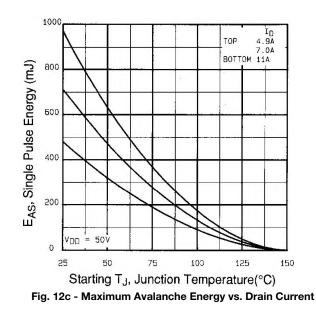
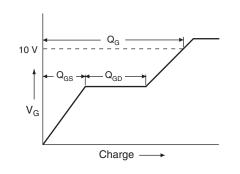
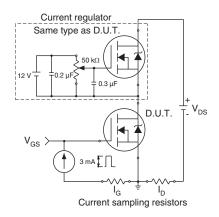


Fig. 12b - Unclamped Inductive Waveforms







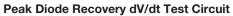


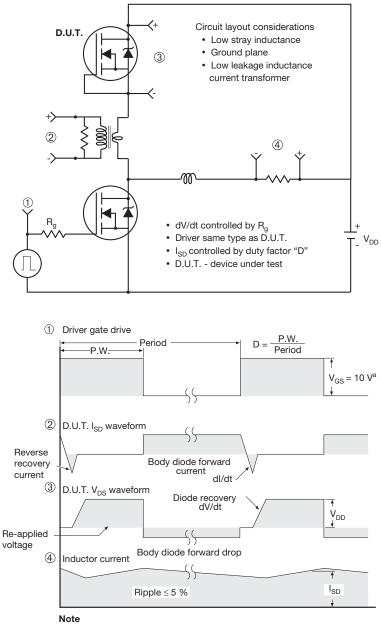


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a.  $V_{GS} = 5$  V for logic level devices

Fig. 14 - For N-Channel

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### TO-247AC (High Voltage)

#### VERSION 1: FACILITY CODE = 9





Section C--C, D--D, E--E

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.83	5.21	
A1	2.29	2.55	
A2	1.50	2.49	
b	1.12	1.33	
b1	1.12	1.28	
b2	1.91	2.39	6
b3	1.91	2.34	
b4	2.87	3.22	6, 8
b5	2.87	3.18	
С	0.55	0.69	6
c1	0.55	0.65	
D	20.40	20.70	4

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D1	16.25	16.85	5
D2	0.56	0.76	
E	15.50	15.87	4
E1	13.46	14.16	5
E2	4.52	5.49	3
е	5.44	BSC	
L	14.90	15.40	
L1	3.96	4.16	6
ØP	3.56	3.65	7
Ø P1	7.19	) ref.	
Q	5.31	5.69	
S	5.54	5.74	

#### Notes

- <sup>(1)</sup> Package reference: JEDEC<sup>®</sup> TO247, variation AC
- (2) All dimensions are in mm
- <sup>(3)</sup> Slot required, notch may be rounded
- <sup>(4)</sup> Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- <sup>(5)</sup> Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition



#### VERSION 2: FACILITY CODE = Y



	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
A	4.58	5.31	
A1	2.21	2.59	
A2	1.17	2.49	
b	0.99	1.40	
b1	0.99	1.35	
b2	1.53	2.39	
b3	1.65	2.37	
b4	2.42	3.43	
b5	2.59	3.38	
С	0.38	0.86	
c1	0.38	0.76	
D	19.71	20.82	
D1	13.08	-	

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D2	0.51	1.30	
E	15.29	15.87	
E1	13.72	-	
е	5.46	BSC	
Øk	0.2	254	
L	14.20	16.25	
L1	3.71	4.29	
ØΡ	3.51	3.66	
Ø P1	-	7.39	
Q	5.31	5.69	
R	4.52	5.49	
S	5.51	BSC	

#### Notes

- <sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994
- <sup>(2)</sup> Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- <sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1
- <sup>(5)</sup> Lead finish uncontrolled in L1
- <sup>(6)</sup> Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- <sup>(7)</sup> Outline conforms to JEDEC outline TO-247 with exception of dimension c



#### VERSION 3: FACILITY CODE = N



MILLIM	MILLIMETERS	MILLIMETERS	MILLIMETERS		
DIM.	MIN.	MAX.	DIM.	MIN.	MAX.
А	4.65	5.31	D2	0.51	1.35
A1	2.21	2.59	E	15.29	15.87
A2	1.17	1.37	E1	13.46	-
b	0.99	1.40	е	5.46	BSC
b1	0.99	1.35	k	0.:	254
b2	1.65	2.39	L	14.20	16.10
b3	1.65	2.34	L1	3.71	4.29
b4	2.59	3.43	N	7.62	BSC
b5	2.59	3.38	Р	3.56	3.66
С	0.38	0.89	P1	-	7.39
c1	0.38	0.84	Q	5.31	5.69
D	19.71	20.70	R	4.52	5.49
D1	13.08	-	S	5.51	BSC

Notes

<sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994

<sup>(2)</sup> Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

<sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1

<sup>(5)</sup> Lead finish uncontrolled in L1

<sup>(6)</sup> Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")



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